

Title (en)

Optical transmitter-receiver module, method of manufacturing said module, and data communication system including said module

Title (de)

Optisches Transmitter-Empfänger Modul, Verfahren zur Herstellung dieses Moduls und Datenkommunikationssystem, das ein solches Modul enthält

Title (fr)

Module optique émetteur-récepteur, procédé de fabrication d'un tel module et système de communication de données incluant un tel module

Publication

**EP 1686404 A3 20060823 (EN)**

Application

**EP 05292369 A 20051108**

Priority

US 4687505 A 20050201

Abstract (en)

[origin: EP2053436A2] An optical module includes a fiber array (4), a laser diode array (6) and a photodiode array (10). The fiber array has optical fibers which are divided to a transmitter group (4a-4d) and a receiver group (4e-4h). The laser diode array has laser diodes which are grouped in a transmitter group. The photodiode array has photodiodes which are divided to a monitor group (10a-10d) and a receiver group (10e-10h). The laser diode array is provided between the fiber array and the photodiode array. Each optical fiber of the transmitter group, each laser diode of the transmitter group and each photodiode of the monitor group are optically aligned, respectively. Each optical fiber of the receiver group is optically aligned with each photodiode of the receiver group, respectively.

IPC 8 full level

**G02B 6/42** (2006.01)

CPC (source: EP US)

**G02B 6/4202** (2013.01 - EP US); **G02B 6/4246** (2013.01 - EP US); **G02B 6/4249** (2013.01 - EP US); **G02B 6/4286** (2013.01 - EP US); **Y10T 29/49117** (2015.01 - EP US)

Citation (search report)

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DOCDB simple family (application)

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